

Features

- Glass passivated junction
- Plastic package P-600
- Bi-directional or Un-directional
- Very Low Clamping Voltage
- High temperature soldering guaranteed: 265°C/10 seconds/.375", (9.5mm) lead length, 5lbs., (2.3kg) tension
- Continued current transient suppressor
- RoHscompliant
- 6KW peak pulse power capability on 10/1000us waveform
- Operating Junction and Storage Temperature Range is -55 to 175
- AEC-Q101

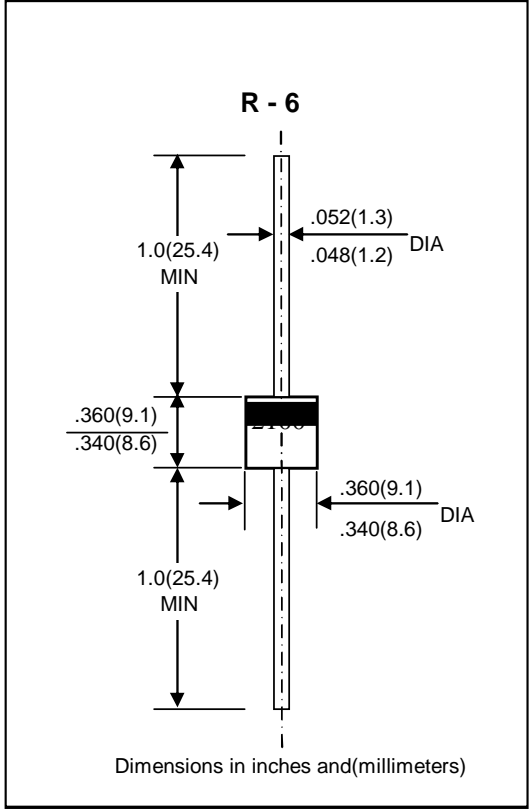
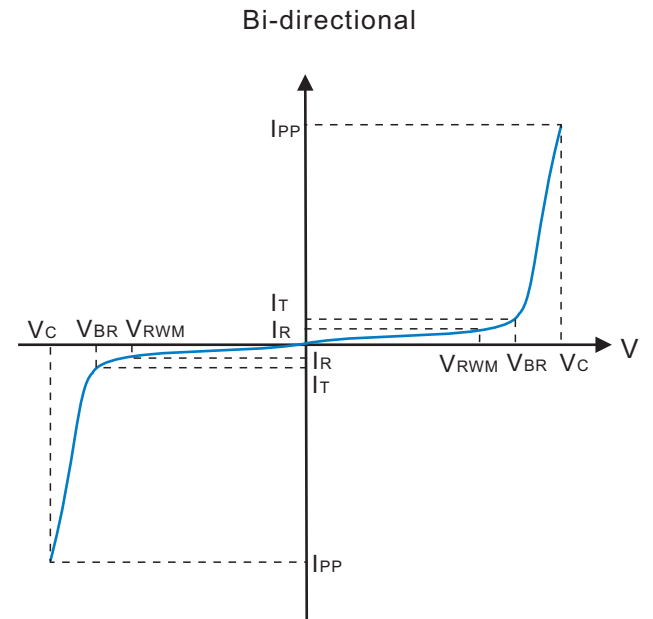
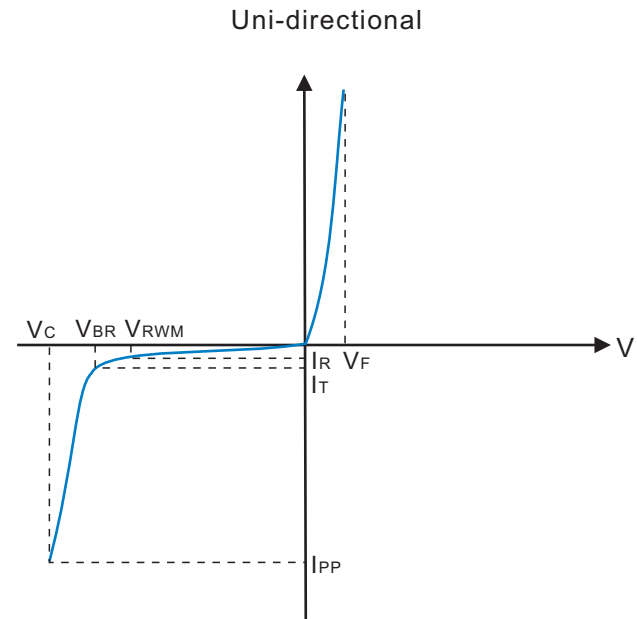
IEC Compatibility

ISO 16750-2 Test A 12V System (87V 1Ω 400ms 10c)
 24V System (174V 4Ω 350ms 10c)

Applications

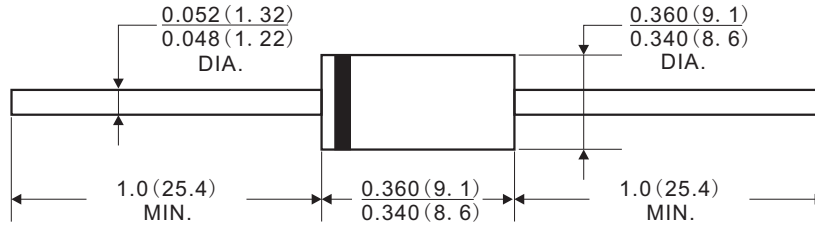
- Auto powers system
- Can-bus
- ABS powers
- Car audio and video
- Automotive instrument
- Bluetooth
- Car GPS

I-V Curve Characteristics



Dimensions (P600)

Case Style P600



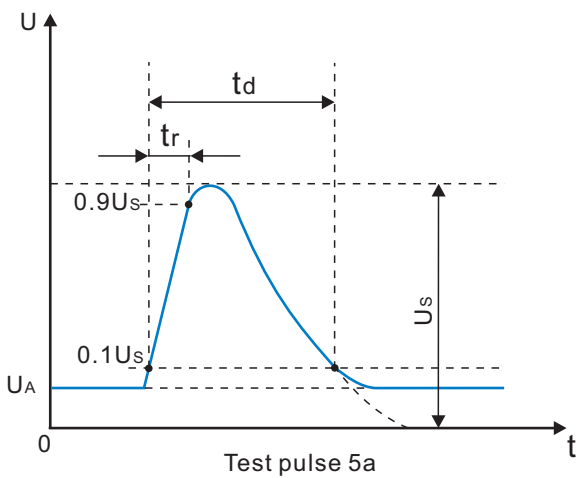
Dimensions in inches and(millimeters)

Electrical Characteristics

**Stand for commonly used models

PKR Part Number		Stand-Off Voltage	Reverse Leakage @ V_{RWM}	Breakdown Voltage @ I_T		Test Current	Max. Clamping Voltage @ $I_{pp} 10/1000\mu s$	
UNI-Polar	BI-Polar	$V_{RWM}(V)$	$I_R(\mu A)$	$V_{BR}(V)Min.$	$V_{BR}(V)Max.$	$I_T(mA)$	$V_c(V)$	$I_{pp}(A)$
* PKR22A	PKR22CA	22	2	24.0	26.9	5	35.5	169.0
PKR24A	PKR24CA	24	2	26.7	29.5	5	38.9	154.2
PKR26A	PKR26CA	26	2	28.9	31.9	5	42.1	142.5
PKR30A	PKR30CA	30	2	33.3	36.8	5	48.4	124.0
PKR33A	* PKR33CA	33	2	36.7	40.6	5	53.3	112.6
PKR36A	PKR36CA	36	2	40.0	44.2	5	58.1	103.3

Test ISO 16750-2 Test A



Parameter	12V System	24V System
U_s	79V to 101V	151V to 202V
R_i	0.5Ω to 4Ω	1Ω to 8Ω
t_d	40ms to 400ms	100ms to 350ms
t_r	$(10^{0}_{-5})ms$	

Ratings and Characteristic Curves (TA=25 °C unless otherwise noted)

Fig.1 Peak Pulse Power Rating Curve

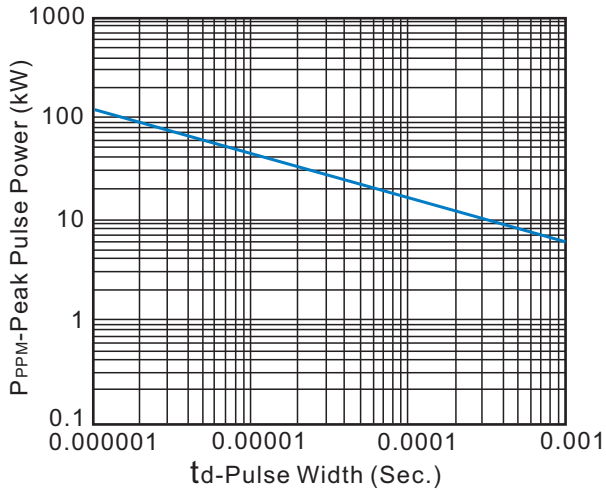


Fig.2 Typical Junction Capacitance

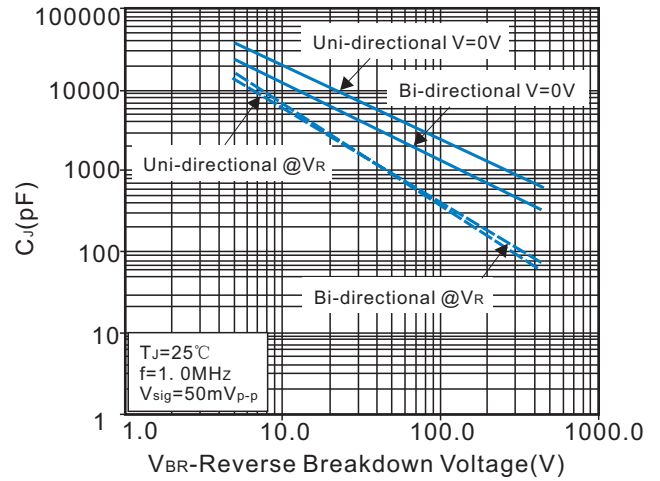


Fig.3 Pulse Waveform

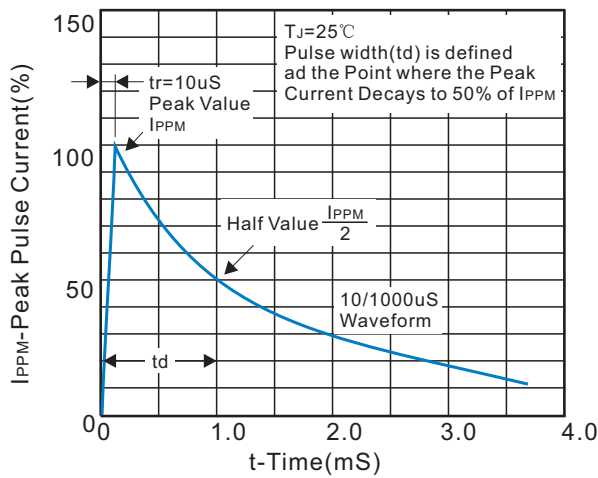


Fig.4 Maximum Non-repetitive Forward Surge

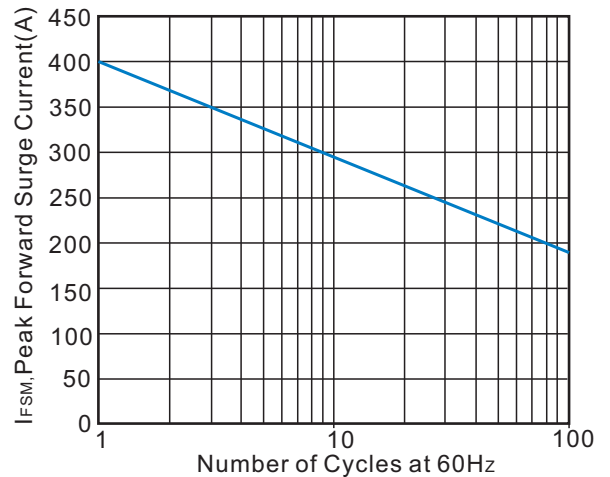


Fig.5 Ri-Vs chart for ISO-16750-2 Test A : 12V System

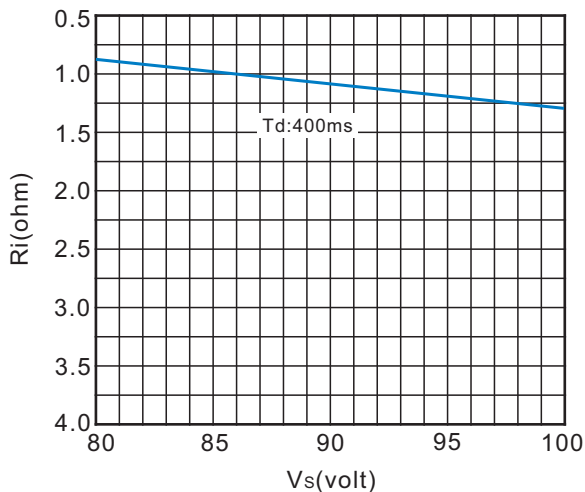
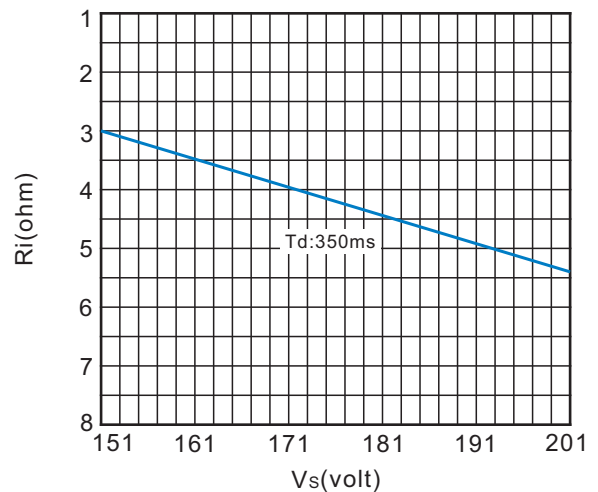
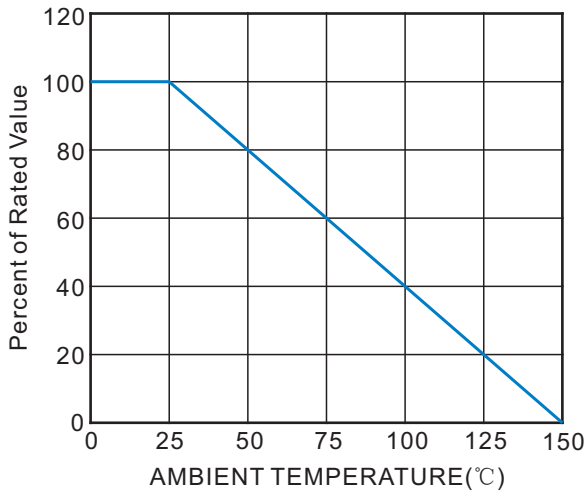


Fig.6 Ri-Vs chart for ISO-16750-2 Test A : 24V System



Ratings and Characteristic Curves (TA=25 °C unless otherwise noted)

Fig.7 Power Derating Curve



Recommended Soldering Conditions

Recommended Conditions

Reflow Condition		Pb-Free assembly (see Fig.1)
Pre Heat	-Temperature Min($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time(Min to Max)(t_s)	60-180secs
Average ramp up rate (Liquidus Temp(T_L) to peak)		3°C/sec.Max.
$T_{s(max)}$ to T_L -Ramp-up Rate		3°C/sec.Max.
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150secs
Peak Temp(T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp(t_P)		30 secs.Max.
Ramp-down Rate		6°C/sec.Max.
Time 25°C to Peak Temp(T_P)		8 min.Max.
Do not exceed		+260°C

Reflow Soldering

